IPC ASSOCIATION CONNECTED ELECTRONICS INDUST	© Copyright 2005. IP	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute									us Materia	als and Mfg	Informati	ion	
Supplier Info	rmation						·								
Company name*			Company un	Company unique ID			Unique ID Authority					Response Date*			
nsemi												2024-04-24			
Contact Name			Title - Contact			I	Phone - Contact*					Email - Contact*			
Product-Env-Ste	wards	Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com				
authorized Repro	esentative*	Title - Representative			I	Phone - Representative*				Email - Representative*					
Product-Env-Ste	wards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Reque	ester Item Number			em Number Mfr Item Name			Effective Dat	e Vers	sion	Manufacturing Site		W	eight*	UOM	Unit Type
				Dual CMOS Am	OS Amplifier		2024-04-24		(CNS		42	42.784 mg		Each
Ianufacturin	g Proccess Informati	ion													
Termin	al Plating / Grid Array Material		Terminal Base Alloy .		J-STD-020 M	D-020 MSL Rating		Peak Process Body Temperatur		re Max Time at Peak Temper		Temperatur	ature Number of Reflow Cycles		eles
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		dAu) (no	CU Alloy 1		1		240		C	30	seco		3		
Comments															
vel 1 - maximun	n time at peak temperatui	re during so	ldering is 10-3	30 seconds											
or more informa	ation regarding material c	omposition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.22	mg	Supplier	Silicon (Si)	7440-21-3		2.22	mg
Die Attach	0.259	mg	Supplier	Silver (Ag)	7440-22-4		0.2072	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.0518	mg
Lead Frame	23.76	mg	Supplier	Zinc (Zn)	7440-66-6		0.029	mg
			Supplier	Iron (Fe)	7439-89-6		0.546	mg
			Supplier	Copper (Cu)	7440-50-8		23.178	mg
			Supplier	Phosphorus (P)	7723-14-0		0.007	mg
Mold Compound-Black	15.9	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.795	mg
			Supplier	Carbon Black (C)	1333-86-4		0.159	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		14.151	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.795	mg
Plating	0.309		Supplier	Palladium (Pd)	7440-05-3		0.028	mg
			В	Nickel (Ni)	7440-02-0		0.277	mg
			Supplier	Gold (Au)	7440-57-5		0.004	mg
Wire Bond - Au	0.336	mg	Supplier	Gold (Au)	7440-57-5		0.336	mg